

## **Application Data Sheet**

### **Application Information**

Application Type:: Regular  
Subject Matter:: Utility  
Suggested classification::  
Suggested Group Art Unit::  
CD-ROM or CD-R?: None  
Title:: Chip scale package with flip chip interconnect  
Attorney Docket Number:: CPAC 1008-2 US  
Request for Early Publication?: No  
Request for Non-Publication?: No  
Suggested Drawing Figure::  
Total Drawing Sheets::  
Small Entity?: No  
Petition included?: No  
Secrecy Order in Parent Appl.?: No

### **Applicant Information**

Applicant Authority Type:: Inventor  
Primary Citizenship Country:: US  
Status:: Full Capacity  
Given Name:: Rajendra  
Family Name:: PENDSE  
City of Residence:: Fremont  
State or Province of Residence:: CA  
Country of Residence:: US  
Street of mailing address:: 5245 Diamond Common  
City of mailing address:: Fremont  
State or Province of mailing address:: CA

Country of mailing address:: US  
Postal or Zip Code of mailing address:: 94555

Applicant Authority Type:: Inventor  
Primary Citizenship Country:: US  
Status:: Full Capacity  
Given Name:: Nazir  
Family Name:: AHMAD  
City of Residence:: San Jose  
State or Province of Residence:: CA  
Country of Residence:: US  
Street of mailing address:: 739 Seawood Way  
City of mailing address:: San Jose  
State or Province of mailing address:: CA  
Country of mailing address:: US  
Postal or Zip Code of mailing address:: 95120

Applicant Authority Type:: Inventor  
Primary Citizenship Country:: US  
Status:: Full Capacity  
Given Name:: Andrea  
Family Name:: CHEN  
City of Residence:: San Jose  
State or Province of Residence:: CA  
Country of Residence:: US  
Street of mailing address:: 6923 Chantel Court  
City of mailing address:: San Jose  
State or Province of mailing address:: CA  
Country of mailing address:: US  
Postal or Zip Code of mailing address:: 95129

20230415 15:41:00

Applicant Authority Type:: Inventor  
Primary Citizenship Country:: Republic of Korea  
Status:: Full Capacity  
Given Name:: Kyung-Moon  
Family Name:: KIM  
City of Residence:: Ichon-si  
State or Province of Residence:: Kyoung ki-do  
Country of Residence:: Republic of Korea  
Street of mailing address:: 312-1 Sadong-ri, Daeyeul-myun  
Samjin Apt., 1-301  
City of mailing address:: Ichon-si  
State or Province of mailing address:: Kyoung ki-do  
Country of mailing address:: Republic of Korea  
Postal or Zip Code of mailing address:: 467-850

Applicant Authority Type:: Inventor  
Primary Citizenship Country:: US  
Status:: Full Capacity  
Given Name:: Young-Do  
Family Name:: KWEON  
City of Residence:: Cupertino  
State or Province of Residence:: CA  
Country of Residence:: US  
Street of mailing address:: 20200 Lucille Avenue, #111  
City of mailing address:: Cupertino  
State or Province of mailing address:: CA  
Country of mailing address:: US  
Postal or Zip Code of mailing address:: 95014

Applicant Authority Type:: Inventor  
 Primary Citizenship Country:: US  
 Status:: Full Capacity  
 Given Name:: Samuel  
 Family Name:: TAM  
 City of Residence:: Daly City  
 State or Province of Residence:: CA  
 Country of Residence:: US  
 Street of mailing address:: 102 Ashland Drive  
 City of mailing address:: Daly City  
 State or Province of mailing address:: CA  
 Country of mailing address:: US  
 Postal or Zip Code of mailing address:: 94015

## Correspondence Information

Correspondence Customer Number:: 22470

## Representative Information

Representative Customer Number::	22470	
----------------------------------	-------	--

## Domestic Priority Information

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	Non-Provisional of	60/272,237	02/27/01

## Assignee Information

Assignee name:: ChipPAC, Inc.  
Street of mailing address:: 47400 Kato Road  
City of mailing address:: Fremont  
State or Province of mailing address:: CA  
Country of mailing address:: US  
Postal or Zip Code of mailing address:: 94538

11/11/2011 10:11:11 AM